

Effect of CSDG MOSFET based High Pass Filter on Signaling

Llewellyn Naidoo, Viranjay M. Srivastava

Abstract: This research work looks at the design of active high pass filter that can be used in mobile communication systems. These systems make use of trans-receiver system. This type of system is commonly used in handsets. In this research work the proposed filter has been designed with a Cylindrical Surrounding Double-Gate (CSDG) MOSFET and operates at cutoff frequency of 100 GHz (0.1 THz). A CSDG MOSFET is an extension of DG MOSFET technology. It is structured by rotation of DG MOSFET with respect to its reference point to form a hollow cylinder. It consists of two gates, one drain and one source. The gain, phase, and return loss of the high pass filter has been analyzed with and without CSDG MOSFET using electronic device simulator. Finally, it has been demonstrated that the third order high pass filters performs better with the CSDG MOSFET.

Index Terms: Active High Pass Filter, CSDG MOSFET, Gain, Phase, Return Loss, Microelectronics, VLSI.

I. INTRODUCTION

The telecommunication sector has evolved from the simple telegraph which was first commercially developed in 1837 by Sir William Fothergill Cooke and Charles Wheatstone [1]. It reduced communication time during the early 1800's from days to hour's just as modern technology as reduced the communication of large amounts of information from hours to seconds [2]. This is due to the rapid changing of technology which has allowed businesses to operate more efficiently and helps keep people connected to one another. One of the largest and thriving segments in telecommunications is wireless communications [3, 4]. Mobile technology is the most common type of wireless communication and is used in cellular communication [5, 6]. This form of communication consists of both consumer part (handset) and infrastructure part (radio base stations). The handset is made up of transmitter and receiver and is known as transceiver system [7]. Receiver is a device that modifies the received signal from transmitter into a desired signal. Figure 1 shows a superheterodyne receiver which was designed by Edwin Armstrong in 1918 is the most widely used today in communication systems. Superheterodyne receivers emit low-power radio signals during normal operation [8]. The incoming signal that is collected by the antenna enters the RF stage where it passes through an RF filter and then an amplifier to provide the initial filtration and amplification of the signal.

Revised Manuscript Received on December 22, 2018.

Llewellyn Naidoo, Department of Electronic Engineering, Howard College, University of KwaZulu-Natal, Durban - 4041, South Africa.

Viranjay M. Srivastava, Department of Electronic Engineering, Howard College, University of KwaZulu-Natal, Durban - 4041, South Africa.

This research work looks at designing an RF filter that can be used in a communications network. This proposed filter builds on the basic filter configuration which has been documented various times in literatures. Compared to these existing works, this proposed filter is designed to operate within the upper ends of the RF spectrum. The advantage of operating at these higher frequencies will allow the filter to work within a greater bandwidth which eventually leads to more information being filtered. Authors first simulated the designed filter and observed the parameters and thereafter looked at the effects adding an additional capacitive model viz. a CSDG MOSFET as on those parameters.

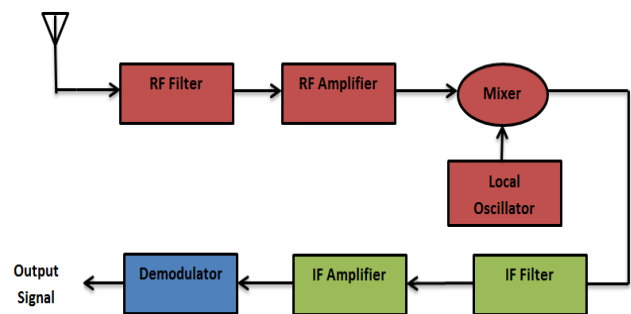


Fig. 1: Superheterodyne receiver [9].

For the RF filter section of this research the aim is to design a filter that can operate at extremely high frequencies. This can be achieved by using capacitor components that have values that are less than $0.002pF$. By using these components the overall capacitance of the filter will be reduced and thus a frequency of $100GHz$ can be achieved more efficiently.

II. BASIC MODEL OF RF FILTER AND CSDG MOSFET

A. RF Filter

The RF filter performs the function of frequency selection by passing signals whose frequencies lie within a specified range whilst preventing the passing of those that fall outside this region [10]. These components are common but critical components in the RF front-end [11]. The two most common types are high and low pass filters. In addition to having low and high pass filters there are variations of these types of filters. Some of these include RC, RL, RLC, LC, and LR filters [12, 13].

Effect of CSDG MOSFET based High Pass Filter on Signaling

Each of the five mentioned filters consists of either a combination of a resistor, inductor or capacitor network and is driven by a voltage or a current source and is referred to as passive filters.

Over the past few decades, passive filters have given rise to active filters [14]. There have been a number of designs in the field of active filters and these filters make use of active components such as an operational amplifier and other electronic components like resistors and capacitors [15]. The advantage of using an active component is that it provides a filter circuit with amplification and gain control. For this design an active high pass filter is considered and is designed to operate at a cutoff frequency of 100 GHz. The following equation is relevant for the design of the op-amp based circuit [16, 17]. The value for C_1 (input capacitance) was chosen as 0.001 pF . So, using $f_c = 1/(2\pi R_2 C_1)$, we get the value of $R_1 = 1 \text{ k}\Omega$ (input resistor). $R_2 = 1 \text{ k}\Omega$ (feedback resistor). The following equations are relevant for the design of the transistor based circuit:

The value for C_3 was chosen has 0.001 pF and $C_2 = 2C_3$, so $C_2 = 0.002 \text{ pF}$. Hence using $f_c = 1.414/(4\pi R_3 C_3)$, we get the value of $R_3 = 1.2 \text{ k}\Omega$.

The value for R_4 has been chosen has $1.8 \text{ k}\Omega$. So, using $R_3 = R_4 R_5 / (R_4 + R_5)$, we get $R_5 = 3.9 \text{ k}\Omega$. Resistors R_4 and R_5 are responsible for setting up the bias point for the transistor base. Also, $R_e(\beta+1) > R_2$, where β is the forward current gain of the transistor and has a value of 60. So, $R_e(60+1) > 1.2 \text{ k}\Omega$. Therefore achieved $R_e = 22 \Omega$ (emitter resistor). The transfer function of the filter is given as:

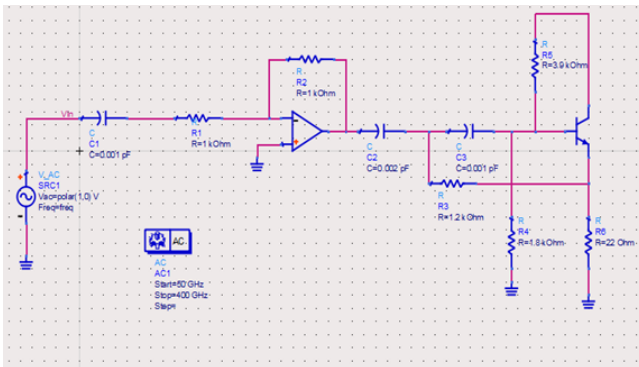


Fig. 2: Circuit design of active high pass filter.

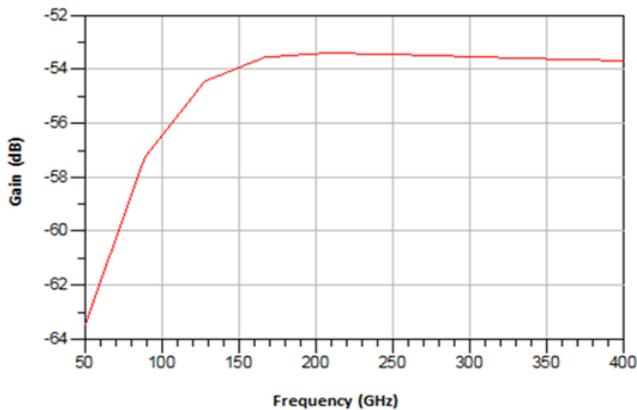


Fig. 3: Frequency response of active high pass filter.

$$T(s) = \frac{R_2 C_1 R_e s^3}{s^3 (R_1 C_1) + s^2 \left(1 + \frac{R_1 C_1}{R_3 C_2} + \frac{R_1 C_1}{R_3 C_3} \right)} + \frac{R_2 C_1 R_e s^3}{s \left(\frac{1}{R_3 C_2} + \frac{1}{R_3 C_3} + \frac{R_1 C_1 (R_4 + R_5)}{R_3 C_2 R_4 R_5 C_3} \right)} + \frac{R_2 C_1 R_e s^3}{\left(\frac{R_4 + R_5}{R_3 C_2 R_4 R_5 C_3} \right)}$$

B. CSDG MOSFET

To further improve the gain of the designed active high pass filter, this section looks at implementing a CSDG MOSFET that can be added at the output of the filter. Since capacitance plays such an important role in the selectivity of frequencies, by using a CSDG MOSFET to act as an additional capacitor not only will the frequency selection be better but also improvements in gain will be observed. The CSDG MOSFET is an extension of a DG MOSFET with numerous benefits [18]. It is formed by rotation of a DG MOSFET with respect to its reference point to form a hollow cylinder [19, 20]. The basic concept of a CSDG MOSFET is to control the Si channel width so there is a smaller contact point at both sides of the channel.

A metal electrode called the Gate is kept apart from the semiconductor by a thin layer of SiO_2 . This thin layer acts as an electrical insulator and occupies the space between the Source and Drain which makes the Gate electrically insulated from the Body [21, 22].

This newer concept of MOSFET design aids in suppressing the Short Channel Effects (SCE) and leads to higher currents as compared with MOSFET using a single gate. It is at the forefront of MOSFET technology and research within this field is consistently growing. Fig. 4 shows the cross sectional area of the CSDG MOSFET.

For this design we have selected $a = 5 \text{ nm}$, $b = 12 \text{ nm}$, $L = 20 \text{ nm}$, $t = 10 \text{ nm}$, and $d = 10 \text{ nm}$, where a , b , L , t and d are the MOSFET's inner radius, outer radius, length of cylinder, junction depth and depth of source respectively. The designed CSDG MOSFET is illustrated in Fig. 5.

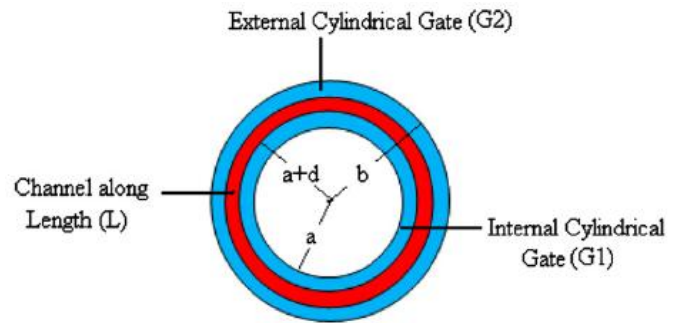


Fig. 4: Cross section of CSDG MOSFET [23].

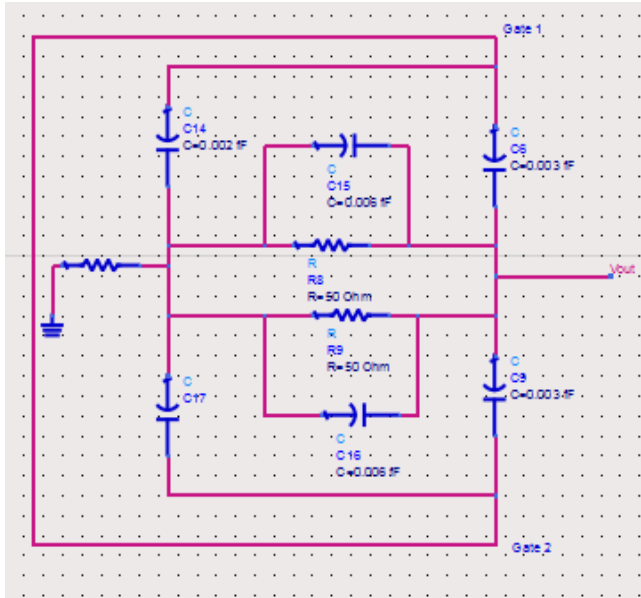


Fig. 5: Basic small signal model of CSDG MOSFET.

C. Filter Suitability in Mobile Communications

A mobile phone operates efficiently by using a highly selective filter. These filters are placed between the antenna and preamplifier and ensure that only signals of the appropriate frequency band will be amplified and the correct signals are received during important functions such as incoming calls and navigation services [24]. If filters are not designed properly it will lead to network problems during these calls.

The proposed filter is designed to operate at frequencies around 100 GHz . This will allow mobile devices to complete multiple functions at once as there is a greater bandwidth to operate. With a greater demand from consumers for their handsets to be more function rich, mobile device manufacturers need their devices to work in the Extremely High Frequency (EHF) Band [25-27].

III. MODELING OF PROPOSED FILTER WITH CSDG MOSFET

The proposed design has merging of active high pass filter and CSDG MOSFET circuits as shown in Fig. 6. The transistor consists of a pair of resistors which create a bias point for the base of transistor whilst the transistor current is set by resistor R_e [23]. By connecting the MOSFET to the output of transistor to act as an additional capacitor, the benefits of the various parameters such as phase, return loss, and gain have been analysed. The later parameter is one of the most important parameters when designing a filter.

The designed MOSFET has been developed with a specification that allows minimal capacitance to be within the circuit. From theory that relates capacitance with frequency, a decrease in capacitance will increase the frequency and will allow the filter to operate at the upper regions of RF spectrum [28].

IV. SIMULATION RESULTS AND ANALYSIS

The designed third order active high pass filter with CSDG MOSFET as shown in Fig. 6 has been simulated using an

electronic device simulator. The gain and phase of the circuit has been observed and are shown in Fig. 7 and Fig. 8, respectively. Since MOSFET is a capacitive model and one of the components that contributes the most to the working of an active filter is a capacitor, the results achieved during simulations is as expected.

From Fig. 7 it can be observe that the frequency increases, the gain of the filter approaches closer to 0 dB . At the cutoff frequency of 0.1 THz we observe a gain of -55.54 dB . Between this point and the frequency where maximum gain is reached we observe -9 dB . This agrees with the theory of how this type of high pass filter should behave since each order of filter will produce -3 dB drop in frequency [29].

Fig. 8 shows the phase response of the filter. Filter has effect on both the amplitude and phase of the signal. From Fourier analysis theory a square wave is made up of a fundamental frequency and odd order harmonics [30, 31]. The phase responses of these harmonics are accurately characterized. If there is a change in the phase relationship the sum of these harmonics will not be equivalent to the square wave. This will result in overshoot has the wave is seen has being distorted.

The proposed filter has a phase shift of 270° at the cutoff frequency. This result also agrees with filter theory behavior and thus we can say that the proposed filter solution has been designed correctly [29].

Fig. 9 shows the improvements in terms of gain and it has been tabled in Table 1. At the cutoff frequency of 100 GHz the difference in gain is 0.63 dB and as the frequency increases, the difference in gains only gets larger, until it reaches its maximum gain. In this case this frequency is approximately 500 GHz . The differences in gain at the cut-off frequency may only be a mere 0.63 dB but considering the frequency domain this active high pass filter is designed for, the newly designed filter will ensure that a considerable amount of additional information is able to be transmitted.

Looking at Fig. 9 we observe that there is a steeper slope for the filter that made use of the CSDG MOSFET compared to the simple filter that didn't. From theory it is known that the steeper the slope of a frequency response graph the greater its ability to provide effective filtering. This means the frequencies below the cut-off frequency will be rejected faster and will thus allow the pass-band signals to be received more efficiently.

Return loss is defined as the ratio of reflected signal ($P_{\text{reflected}}$) to input signal (P_{in}). Often return loss is expressed has a positive integer such as 20 dBm . But it's really meant to be a negative integer because return loss is always lower than the input signal. The return loss is given by the following equation [32, 33]:

$$RL = 10 \log \left(\frac{P_{\text{reflected}}}{P_{\text{in}}} \right)$$

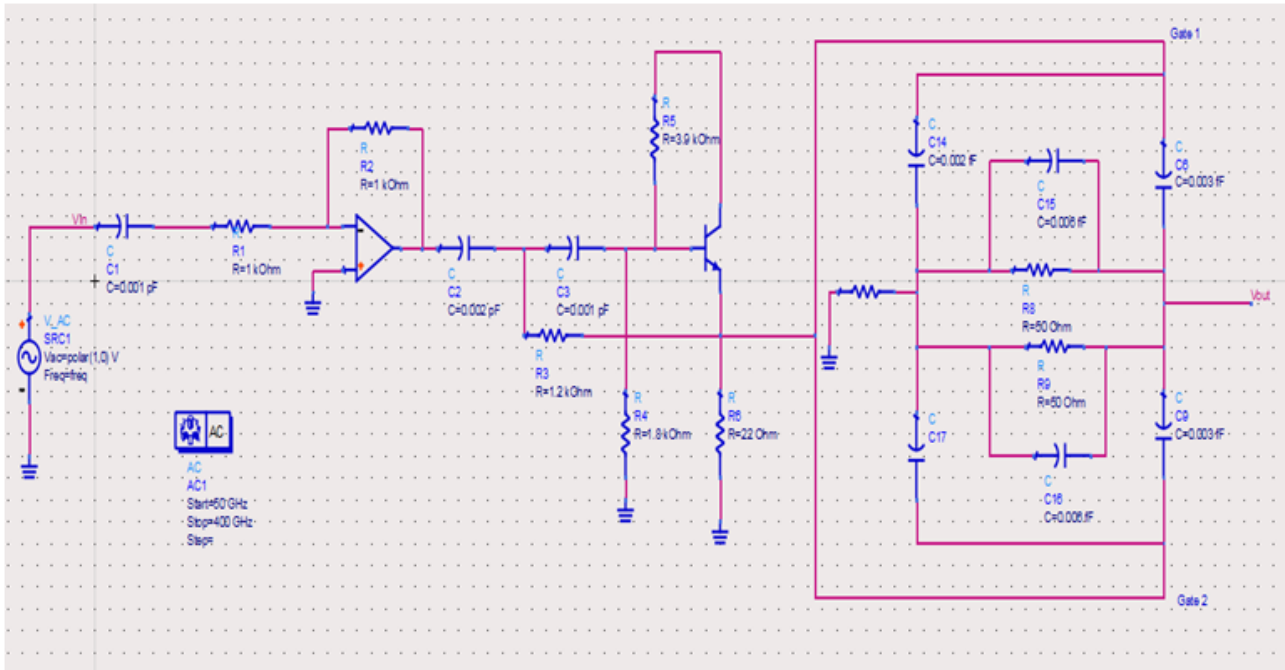


Fig. 6: MOSFET active high pass filter.

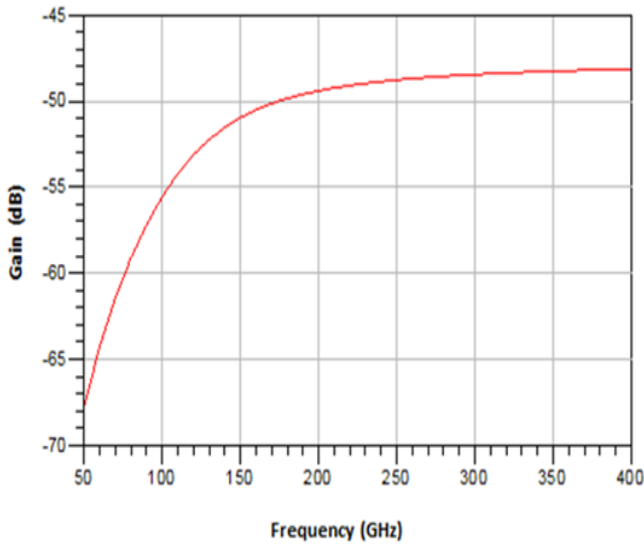


Fig. 7: Gain of proposed filter.

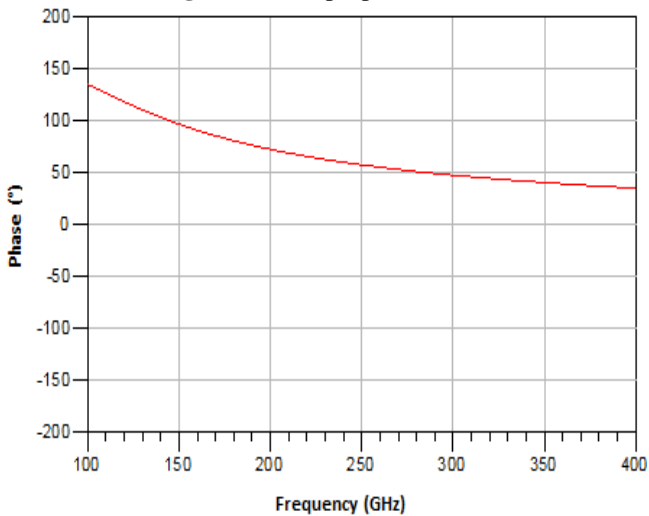


Fig. 8: Phase of proposed filter.

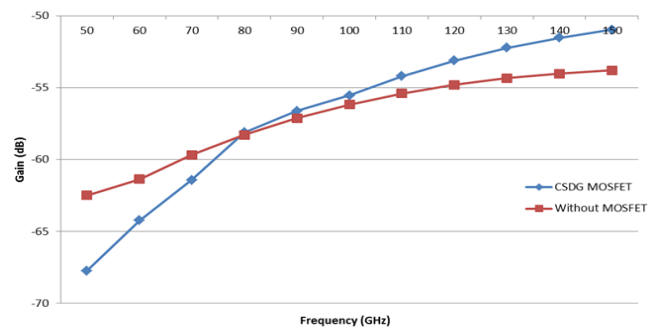


Fig. 9: Comparison of gains.

Table 1: Comparison of Gains of Filters

| Frequency (GHz) | Gain (dB) | | |
|-----------------|------------------|---------------------|------------|
| | With CSDG MOSFET | Without CSDG MOSFET | Difference |
| 50 | -67.74 | -63.48 | -4.26 |
| 60 | -64.23 | -61.37 | -2.36 |
| 70 | -61.42 | -59.68 | -1.74 |
| 80 | -58.10 | -58.29 | 0.19 |
| 90 | -56.62 | -57.13 | 0.51 |
| 100 | -55.54 | -56.17 | 0.63 |
| 110 | -54.20 | -55.40 | 1.2 |
| 120 | -53.11 | -54.80 | 1.69 |
| 130 | -52.23 | -54.34 | 2.11 |
| 140 | -51.52 | -54.02 | 2.50 |
| 150 | -50.96 | -53.79 | 2.83 |

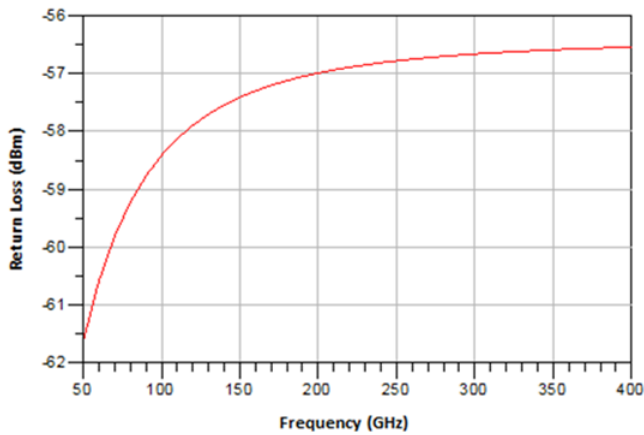


Fig. 10: Return loss.

Fig. 10 shows the return loss of the designed filter that can be implemented in a remote controlled device. Return loss of -58.4 dBm has been observed. This is the power ratio which is in decibels (dB) of the measured power and is then associated with 1 mW. The closer the value is to 0 dBm the stronger the signal will be.

This result may be far from the desired result of 0 dBm but with technology and components rapidly improving we can achieve results that are closer to the desired result and thus ensuring that the signal delivered is of a more considerable strength. However, considering the frequency domain the designed active high pass filter is operating in this is a good start to research work relating return loss to cut-off frequency.

V. CONCLUSIONS AND FUTURE WORKS

This work analysed the design and simulation of active high pass filter with CSDG MOSFET that could be used in mobile communication systems. An active filter has been chosen to be designed over a passive filter since it is efficient, costs and its weight is kept to a minimum and one can control the overall gain of the filter. The design of the active filter made use of two active components viz. operational amplifier and transistor. The transistor was implemented in this design as we require to achieve frequencies that are higher of the RF spectrum whilst providing the levels of gain that are required for a filter to deliver its information efficiently and an operational amplifier helped with this aspect of the design.

In addition a CSDG MOSFET was added to the output of the circuit to see what effect it had on the gain of the designed filter. The newly designed filter offers better gain compared to a filter that made use of an operational amplifier and transistor that formed an active filter. It was also found that the return loss was improved.

Future work will involve achieving a better gain which is closer to unity which will ensure that more information is received. This will be achieved with technology improvements and further research can be carry forward in the field of CSDG MOSFET's and various types of gate oxides that could be a potential replacement for the SiO_2 layer.

REFERENCES

1. B. Bowers, "Inventors of the telegraph," *Proceedings of the IEEE*, vol. 90, no. 3, pp. 436-439, March 2002.
2. Amos Joel, "Telecommunications and the IEEE communications society," *IEEE Communications Magazine*, vol. 40, no. 5, pp. 6-162, May 2002.
3. He Huang and Yuh Shyan Chen, *Advances in Communication Systems and Electrical Engineering*, 1st Ed., Springer, USA, Nov. 2008.
4. Seyed A. Bassam, Wenhua Chen, Mohamed Helaoui, and Fadhel M. Ghannouchi, "Transmitter architecture for CA: Carrier Aggregation in LTE-advanced systems," *IEEE Microwave Magazine*, vol. 14, no. 5, pp. 78-86, July-Aug. 2013.
5. Sultan Shoaib, Imran Shoaib, Noshwan Shoaib, Xiaodong Chen, and Clive G. Parini, "MIMO antennas for mobile handsets," *IEEE Antennas and Wireless Propagation Letters*, vol. 14, pp. 799-802, 2015.
6. Narseo V. Rodriguez and Jon Crowcroft, "Energy Management Techniques in Modern Mobile Handsets," *IEEE Communications Surveys & Tutorials*, vol. 15, no. 1, pp. 179-198, 2013.
7. Sajal K. Das, *Mobile Handset Design*, John Wiley & Sons (Asia) Pte. Ltd., 2013.
8. Colin Stagner, , Andrew Conrad, Christopher Osterwise, , Daryl G. Beetner, and Steven Grant, "A practical superheterodyne-receiver detector using stimulated emissions," *IEEE Transactions on Instrumentation and Measurement*, vol. 6, no. 4, pp. 1461 - 1468, Jan. 2011.
9. A. M. Korolev, "An intermediate-frequency amplifier for a radio-astronomy superheterodyne receiver," *Instruments and Experimental Techniques*, vol. 54, no. 1, pp. 81-83, Jan. 2011.
10. Kun Wang and Clark T. C. Nguyen, "High-order medium frequency micromechanical electronic filters," *Journal of Microelectro-mechanical Systems*, vol. 8, no. 4, pp. 534-557, Dec. 1999.
11. Xiaoguang Liu, "Tunable RF and microwave filters," *IEEE 16th Annual Wireless and Microwave Technology Conference (WAMICON)*, Florida, USA, 13-15 April 2015, pp. 1-5.
12. Adel S. Sedra and Kenneth C. Smith, *Microelectronic Circuits: Theory and Applications*, 7th Ed., Oxford University Press, USA, 2014.
13. Alphonse J. Sistino, *Essentials of Electronic Circuitry: Analysis and Design*, CRC Press, 1996.
14. H. G. Dimopoulos, *Analog Electronic Filters: Theory, Design and Synthesis*, 1st Ed., Springer, 2012.
15. P. V. Ananda Mohan, *VLSI Analog Filters*, 1st Ed. Springer Science & Business Media, New York, United States of America, 2013.
16. S. A. Pactitis, *Active Filters: Theory and Design*, CRC Press, Taylor & Francis Group, Nov. 2011.
17. Alphonse J. Sistino, *Essentials of Electronic Circuitry: Analysis and Design*, 1st Ed., CRC Press, Taylor & Francis Group, March, 1996.
18. Viranjay M. Srivastava, K. S. Yadav, and G. Singh, "Design and performance analysis of double-gate MOSFET over single-gate MOSFET for RF switch," *Microelectronics Journal*, vol. 42, no. 3, pp. 527-534, March 2011.
19. Llewellyn Naidoo and Viranjay M. Srivastava, "Application of CSDG MOSFET for Tera-hertz range in high pass filtering," *Far East Journal of Electronics and Communications*, vol. 18, no. 5, pp. 651-660, July 2018.
20. Viranjay M. Srivastava and G. Singh, *MOSFET Technologies For Double-Pole Four Throw Radio Frequency Switch*, Springer International Publishing, Switzerland, Oct. 2013.
21. Sung M. Kang, Yusuf Leblebici, and Chul W. Kim, *CMOS Digital Integrated Circuit Analysis & Design*, 4th Ed., McGraw Hill, New York, USA, 2015.
22. Sorab K. Gandhi, *VLSI Fabrication Principles: Silicon and Gallium Arsenide*, 2nd Ed., Wiley, 1994.
23. Llewellyn Naidoo and Viranjay M. Srivastava, "Application of high pass filter in robotics: a circuit perspective," *International Conference on Computer Communication and Informatics (ICCCI -2018)*, Coimbatore, India, 4-6 Jan. 2018, pp. 131-134.
24. R. Aigner, S. Marksteiner, L. Elbrecht, and W. Nessler, "RF-filters in mobile phone applications", *12th International Conference on Solid State Sensors, Actuators and Microsystems*, Boston, MA, USA, 8-12 June 2003, pp. 891-894.

25. Li Da Xu, Wu He, and Shancang Li, "Internet of things in industries: a survey," *IEEE Transactions on Industrial Informatics*, vol. 10, no. 4, pp. 2233 – 2243, Nov. 2014.
26. Arash Asadi, Qing Wang, and Vincenzo Mancuso, "A Survey on Device-to-Device Communication in Cellular Networks," *IEEE Communications Surveys & Tutorials*, vol. 16, no. 4, April 2014)
27. Amitava Ghosh, Timothy A. Thomas, Mark C. Cudak, Rapeepat Ratasuk, Prakash Moorut, Frederick W. Vook, Theodore S. Rappaport, George R. MacCartney, Shu Sun, and Shuai Nie, "Millimeter-wave enhanced local area systems: a high-data-rate approach for future wireless networks," *IEEE Journal on Selected Areas in Communications*, vol. 32, no. 6, pp. 1152 – 1163, June 2014.
28. Yannis Tsividis and Colin McAndrew, *Operation and Modeling of the MOS Transistor*, 3rd Ed., Oxford University Press, Oct. 2010.
29. Steve Winder, *Analog and Digital Filter Design*, 2nd Ed., Newnes, Elsevier, Oct. 2002.
30. Walt Jung, *Op Amp Applications Handbook*, 1st Ed., Elsevier, Nov. 2004.
31. John G. Proakis and Dimitris G. Manolakis, *Digital Signal Processing: Principles, Algorithms, and Applications*, 4th Ed., Pearson Education, 2007.
32. Ian Hunter, *Theory and Design of Microwave Filters*, IET Electromagnetic Waves Series 48, University Press, Cambridge, UK, 2006.
33. Constantine A. Balanis, *Antenna Theory: Analysis and Design*, 4th Ed., Wiley, Feb. 2016.